



FORM PTO-1449 (MODIFIED)	ATTY. DOCKET NO. 36856.366	SERIAL NO.: 09/692,668
LIST OF PATENTS AND PUBLICATIONS FOR APPLICANTS INFORMATION DISCLOSURE STATEMENT (USE SEVERAL SHEETS IF NECESSARY)	APPLICANT(S): Takao MUKAI et al.	
FILING DATE: October 20, 2000	GROUP: 2834	

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Reference Designation

U.S. Patents

Examiner Initial	Document Number	Date	Name	Class	Filing Date Subclass if appropriate
	AA				
	AB				
	AC				
	AD				
	AE				
	AF				
FOREIGN PATENT DOCUMENTS					
	Document Number	Date	Country	Class	Filing Date Subclass if appropriate
JK	AG 7-297074 (with English Abstract)	11/1995	Japan		
JK	AH 7-142904 (with English Abstract)	06/1995	Japan		
JK	AI 9-190947 (with English Abstract)	07/1997	Japan		
	AJ				
	AK				
	AL				
	AM				
	AN				
	AO				
OTHER ART (INCLUDING AUTHOR, TITLE, DATE, PERTINENT PAGES, ETC.)					
JK	AP M. O'NEILL; "A Low Temperature Co-Fire Ceramic Materials System for High Performance Commercial Applications"; ISPS '97 Proceedings, December 2-5, 1997; pp.135-140.				
JK	AR C. MAKIHARA et al.; "Multifunctional Ceramic Substrates and Packages for Telecommunication Applications"; ISHM '94 Proceedings Nov. 15-17, 1994; pp. 243-247.				
JK	AS M. KATO et al.; "Application of Low Temperature Fired Multilayered Substrates to High Frequency"; ISHM '92 Proceedings; Oct. 19-21, 1992; pp.263-268.				
JK	AT P.C. DONOHUE et al.; "High Reliability Copper MCM Systems"; ISHM '92 Proceedings, Oct. 19-21, 1992; pp. 607-612.				
EXAMINER	DATE CONSIDERED				
	John Gonzalez				06/27/03
EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.					